

Sir:

In response to the Office Action of May 24, 2002, please amend the above-identified application as follows:

**In the Specification:**

Please replace the following paragraph:

Replace the paragraph beginning at page 1, line 25 with the following rewritten paragraph:

91 --U.S.Pat.No.5,704,981 issued January 6, 1998 to Kawakami et al., recites a buffer plate for distributing gas in a reactor.--

**In the Claims:**

Please cancel claims 1 - 10.

Please amend claims 11-17 as follows:

Subb1  
92 11. (AMENDED) A method for removing organic materials from a plurality of substrates having surface patterns with prominent sidewalls